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GLF71315

Ultra-Efficient, I_QSmart[™] Load Switch with Slew Rate Control

Product Specification

DESCRIPTION

The GLF71315 is an ultra-efficiency, 2A rated, Load Switch with integrated slew rate control. The best in class efficiency makes it an ideal chose for use in IoT, mobile, and wearable electronics.

The GLF71315 features ultra-efficient I_QSmart^{TM} technology that supports the lowest quiescent current (I_Q) and shutdown current (I_{SD}) in the industry. Low I_Q and I_{SD} solutions help designers to reduce parasitic leakage current, improve system efficiency, and increase battery lifetime.

The GLF71315 integrated slew rate control can also enhance system reliability by mitigating bus voltage swings during switching events. Where uncontrolled switches can generate high inrush currents that result in voltage droop and/or bus reset events, the GLF slew rate control specifically limits inrush currents during turn-on to minimize voltage droop.

GLF71315 Load Switch devices support an industry leading wide input voltage range and helps to improve operating life and system robustness. Furthermore, one device can be used in multiple voltage rail applications which helps to simplify inventory management and reduce operating cost.

GLF71315 Load Switch device is small utilizing a chip scale package with 4 bumps in a 0.97mm x 0.97mm x0.55mm die size and a 0.5mm bump pitch.

FEATURES

Ultra-Low I_Ω: 7nA Typ @ 5.5V_{IN}
 Ultra-Low I_{SD}: 28nA Typ @ 5.5V_{IN}
 Low R_{ON}: 31mΩ Typ @ 5.5V_{IN}

I_{OUT} Max: 2A

• Wide Input Range: 1.1V to 5.5V

6V abs max

Controlled Rise Time: 335us at 3.3V_{IN}

Internal EN Pull-Down Resistor

Integrated Output Discharge Switch

 Wide Operating Temperature Range: -40°C ~ 105°C

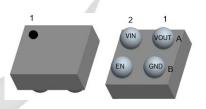
HBM: 6kV, CDM: 2kV

Ultra-Small: 0.97mm x 0.97mm WLCSP

APPLICATIONS

- Wearables
- Data Storage, SSD
- Mobile Devices
- Low Power Subsystems

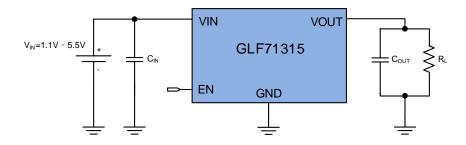
PACKAGE



0.97mm x 0.97mm x 0.55mm WLCSP

APPLICATION DIAGRAM

Rev. C, June. 15, 2017



ORDERING INFORMATION

Part Number	Top Mark	R _{ON} (Typ) at 5.5V	Output Discharge	EN Activity
GLF71315	НС	31 mΩ	85Ω	High

FUNCTIONAL BLOCK DIAGRAM

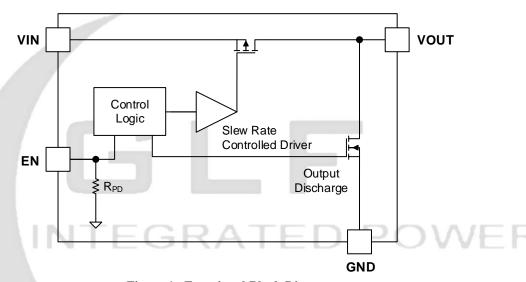


Figure 1. Functional Block Diagram

PIN CONFIGURATION

1 2 1 VIN VOUT A EN GND B Top View Bottom View

Figure 2. 0.97mm x 0.97mm x 0.55mm WLCSP

PIN DEFINITION

Pin#	Name	Description
A1	Vouт	Switch Output
A2	Vin	Switch Input. Supply Voltage for IC
B1	GND	Ground
B2	EN	Enable to control the switch

ABSOLUTE MAXIMUM RATINGS

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions; extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only.

Symbol	Par	Min.	Max.	Unit	
Vin	VIN, VOUT, VEN tO GND		-0.3	6	V
lout	Maximum Continuous Switch Current			2	Α
PD	Power Dissipation at T _A = 25°C			1.2	W
Tstg	Storage Junction Temperature			150	°C
TA	Operating Temperature Range			105	°C
θја	Thermal Resistance, Junction to Ambient			85	°C/W
ECD	Floatroatatia Diagharga Canability	Human Body Model, JESD22-A114	6		1417
ESD	Electrostatic Discharge Capability	Charged Device Model, JESD22-C101	2		kV

RECOMMENDED OPERATING CONDITIONS

Symbol	Parameter	Min.	Max.	Unit
V _{IN}	Supply Voltage	1.1	5.5	V
TA	Ambient Operating Temperature	-40	+105	°C



ELECTRICAL CHARACTERISTICS

Values are at V_{IN} = 3.3V and T_A = 25°C unless otherwise noted.

Symbol	Parameter	Conditions		Min.	Тур.	Max.	Units	
Basic Ope	eration							
V _{IN}	Supply Voltage			1.1		5.5	V	
		EN = Enable, I _{OUT} =0mA, V _{IN} = V _{EN} :		7	70			
ΙQ	Quiescent Current (1)	EN=Enable, I _{OUT} =0mA, V _{IN} =V _{EN} =5.5V, Ta=85°C (5)			12		nA	
		EN=Enable, Iout=0mA, Vin=Ven=5.	5V, Ta=105°C ⁽⁵⁾		17		1	
		EN = Disable, I _{OUT} =0mA, V _{IN} =1.1V			5			
		EN = Disable, I _{OUT} =0mA, V _{IN} =1.8V			6			
	I _{SD} Shut Down Current	EN = Disable, I _{OUT} =0mA, V _{IN} =3.3V			9	35	nA	
I _{SD}		EN = Disable, I _{OUT} =0mA, V _{IN} =4.5V			13			
		EN = Disable, I _{OUT} =0mA, V _{IN} =5.5V			28	100		
		EN = Disable, I _{OUT} =0mA, V _{IN} =5.5V,	Ta=85°C (5)		1			
		EN = Disable, I _{OUT} =0mA, V _{IN} =5.5V,	Ta=105°C (5)		2.7		– uA	
			Ta=25°C		31	34		
		V _{IN} =5.5V, I _{OUT} = 500mA	Ta=85°C (5)		36			
			Ta=105°C (5)		39		-	
			Ta=25°C		36	41	1	
Ron	On-Resistance	V _{IN} =3.3V, I _{OUT} = 500mA	Ta=85°C (5)		43		mΩ	
A	I IN	TEGRAT	Ta=105°C (5)		46	FF	3	
		V _{IN} =1.8V, I _{OUT} = 300mA	Ta=25°C		52			
		V _{IN} =1.1V, I _{OUT} = 100mA	Ta=25°C		95			
Rosc	Output Discharge Resistance	E _N =Low, I _{FORCE} = 10mA		70	85	100	Ω	
\ /	EN Input Logic High	V _{IN} =1.1V - 1.8V		0.9			V	
V _{IH}	Voltage	V _{IN} =1.8V - 5.5V		1.2			V	
VıL	EN Input Logic Low	V _{IN} =1.1V - 1.8V				0.3	V	
VIL	Voltage	V _{IN} =1.8V - 5.5V				0.4	٧	
Ren	EN pull down resistance	Internal Resistance			9.5		МΩ	
I _{EN}	EN Current	E _N =5.5V				1.0	μA	
Switching	Characteristics							
t _{dON}	Turn-On Delay (2)	P. 1500 Carrage 1115			210			
t _R	Vout Rise Time (2)	R _L =150Ω, C _{OUT} =0.1μF			335			
t _{dON}	Turn-On Delay (2,5)	R _L =500Ω, C _{OUT} =0.1μF			220		μs	
t_R	V _{OUT} Rise Time (2,5)				330			
tdOFF	Turn-Off Delay (3,4,5)	R _L =10Ω, C _{OUT} =0.1μF			0.38		μ ^ο	
t _F	V _{OUT} Fall Time (3,4,5)	πι-1032, 0001-0.1μΓ			1.3			
tdOFF	Turn-Off Delay (3,4,5)	RL=500Ω, Cουτ=0.1μF			0.9			
t⊧	V _{OUT} Fall Time (3,4,5)	πι-30022, Ο001-0.1μΓ			16			

Notes:

1. I_Q does NOT include Enable pull down current through the pull down resistor R_{PD} .

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- $2. \quad t_{\text{ON}} = t_{\text{dON}} + t_{\text{R}}$
- 3. $t_{OFF} = t_{dOFF} + t_F$
- 4. Output discharge path is enabled during off.
- 5. By design; characterized, not production tested.

Ultra-Efficient, I_QSmart[™] Load Switch with Slew Rate Control

TIMING DIAGRAM

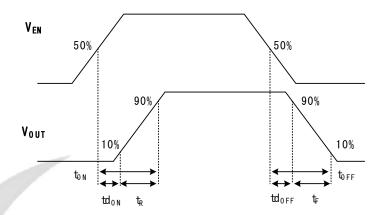


Figure 2. Timing Diagram



Ultra-Efficient, I_QSmart[™] Load Switch with Slew Rate Control

TYPICAL PERFORMANCE CHARACTERISTICS

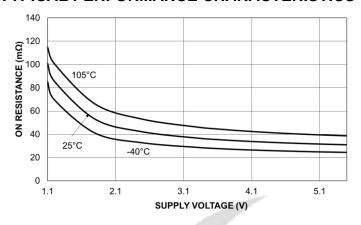


Figure 3. On-Resistance vs. Input Voltage

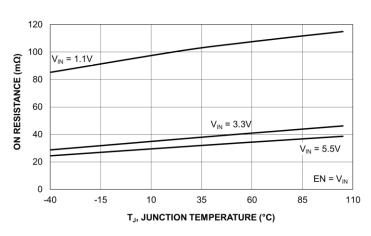


Figure 4. On-Resistance vs. Temperature

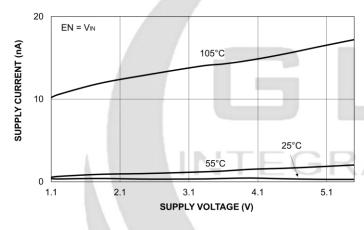
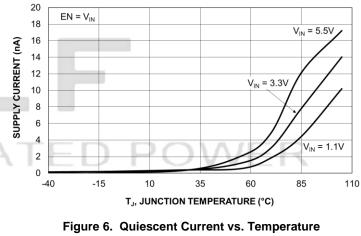


Figure 5. Quiescent Current vs. Input Voltage



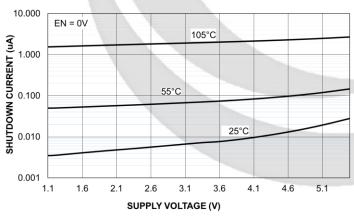


Figure 7. Shut Down Current vs. Input Voltage

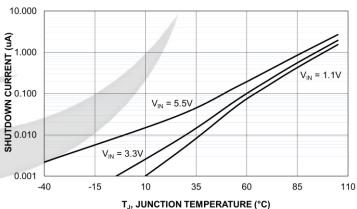
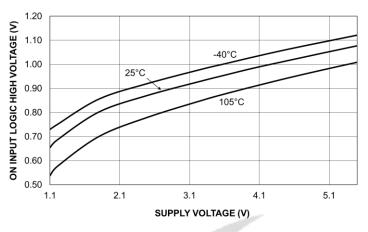


Figure 8. Shut Down Current vs. Temperature

Ultra-Efficient, I_QSmart[™] Load Switch with Slew Rate Control



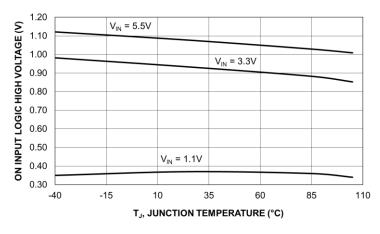
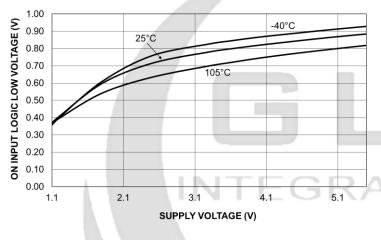


Figure 9. EN Input Logic High Threshold

Figure 10. EN Input Logic High Threshold Vs. Temperature



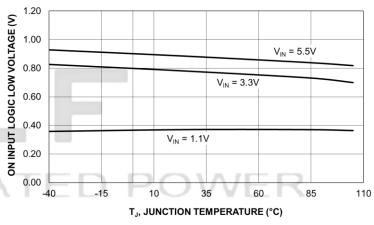
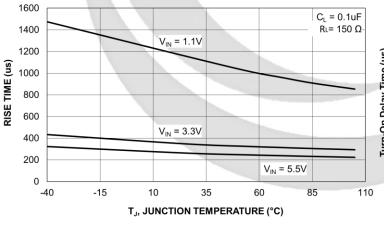


Figure 11. EN Input Logic Low Threshold

Figure 12. EN Input Logic Low Threshold Vs. Temperature



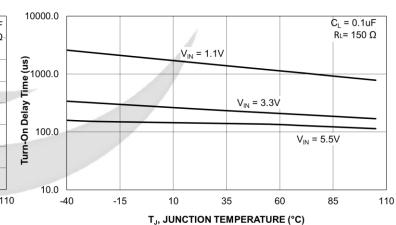


Figure 13. VOUT Rise Time vs. Temperature

Figure 14. Turn-On Delay Time vs. Temperature

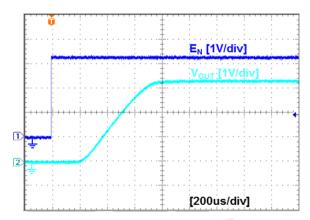


Figure 15. Turn-On Response $V_{IN}=3.3V$, $C_{IN}=1.0uF$, $C_{OUT}=0.1uF$, $R_L=10\Omega$

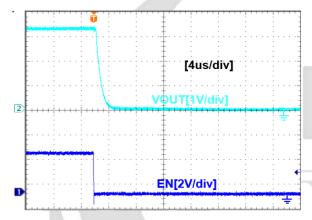


Figure 17. Turn-Off Response, Output Discharge $V_{IN}=3.3V$, $C_{IN}=1.0uF$, $C_{OUT}=0.1uF$, $R_L=10\Omega$

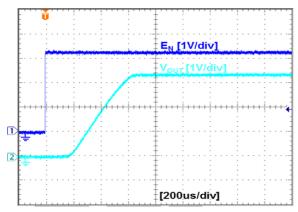


Figure 16. Turn-On Response $V_{IN}=3.3V, C_{IN}=1.0uF, C_{OUT}=0.1uF, R_L=500\Omega$

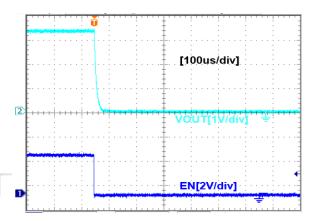


Figure 18. Turn-Off Response, Output Discharge V_{IN} =3.3V, C_{IN} =1.0uF, C_{OUT} =0.1uF, R_L =500 Ω

Ultra-Efficient, IoSmart[™] Load Switch with Slew Rate Control

APPLICATION INFORMATION

The GLF71315 is an integrated 2A, Ultra-Efficient I_QSmart[™] Load Switch device with a fixed slew rate control to limit the inrush current during turn on. Each device is capable of operating over a wide input range from 1.1V to 5.5V with very low on-resistance to reduce conduction loss. In the off state, these devices consume very low leakage current to avoid unwanted standby current and save limited input power. The package is a 0.97mm x 0.97mm x 0.55mm wafer level chip scale package, saving space in compact applications. It is constructed using 4 bumps, with a 0.5mm pitch for manufacturability.

Input Capacitor

A capacitor is recommended to be placed close to the V_{IN} pin to reduce the voltage drop on the input power rail caused by transient inrush current at start-up. A higher input capacitor value can be used to further attenuate the input voltage drop.

Output Capacitor

An output capacitor is recommended to mitigate voltage undershoot on the output pin when the switch is turning off. Undershoot can be caused by parasitic inductance from board traces or intentional load inductances. If load inductances do exist, use of an output capacitor can improve output voltage stability and system reliability. The Cout capacitor should be spaced close to the VOUT and GND pins.

EN pin

The GLF71315 can be activated by forcing EN pin high level. Note that the EN pin has an internal pull-down resistor to help pull the main switch to a known "off state" when no EN signal is applied from an external controller.

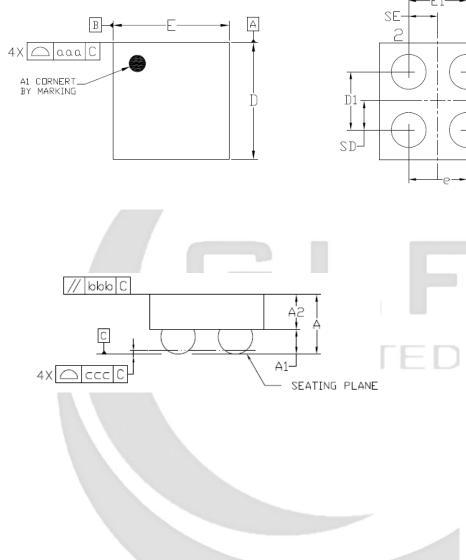
Output Discharge Function

The GLF71315 has an internal discharge N-channel FET switch on the VOUT pin. When EN signal turns the main power FET to an off state, the N-channel switch turns on to discharge an output capacitor quickly.

Board Layout

All traces should be as short as possible to minimize parasitic inductance effects. Wide traces for VIN, VOUT, and GND will help reduce signal degradation and parasitic effects during dynamic operation as well as improve the thermal performance at high load current.

PACKAGE OUTLINE



Notes							
1 ALL DIME	SANTIZM	F IN	MTLI	IMETERS	(ANGLES	ΤN	DEGREES).

2. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M-1994.

Dimensional Ref.									
REF.	Min.	Nom.	Max.						
Α	0.500	0.550	0.600						
Α1	0.225	0.250	0.275						
Α2	0.275	0.300	0.325						
D	0.955	0.970	0.985						
Е	0.955	0.970	0.985						
D1	0.450	0.500	0.550						
E1	0.450	0.500	0.550						
Ь	0.260	0.310	0.360						
е	0	.500 BS							
SD	0	.250 BS							
SE	0	.250 BS							
To	ol. of Fo	rm&Pos	sition						
999	0.10								
ььь	0.10								
CCC	0.05								
ddd		0.05							

4X Øb

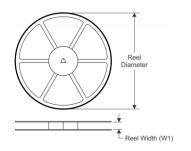
◆ ØdddM C B A

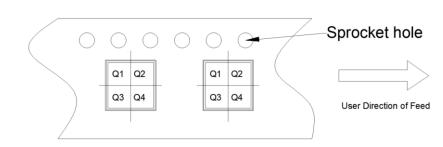


TAPE AND REEL INFORMATION

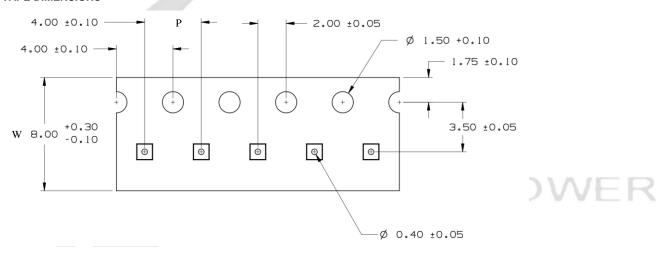
REEL DIMENSIONS

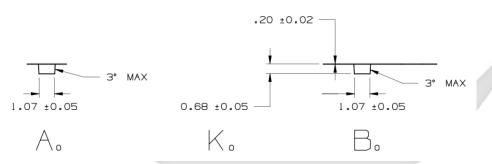
QUADRANT ASSIGNMENTS PIN 1 ORIENTATION TAPE





TAPE DIMENSIONS





Device	Package	Pins	SPQ	Reel Diameter(mm)	Reel Width W1	Α0	В0	K0	Р	W	Pin1
GLF71315	WLCSP	4	3000	180	9	1.07	1.07	0.68	4	8	Q1

Remark:

- A0: Dimension designed to accommodate the component width
- B0: Dimension designed to accommodate the component length
- C0: Dimension designed to accommodate the component thickness
- W: Overall width of the carrier tape
- P: Pitch between successive cavity centers

SPECIFICATION DEFINITIONS

Document Type	Meaning	Product Status
Target Specification	This is a target specification intended to support exploration and discussion of critical needs for a proposed or target device. Spec limits including typical, minimum, and maximum values are desired, or target, limits. GLF reserves the right to change limits at any time without warning or notification. A target specification in no way guarantees future production of the device in question.	Design / Development
Preliminary Specification	This is a preliminary version of a product specification. The specification is still under internal review and subject to change. GLF reserves the right to change the specification at any time without warning or notification. A preliminary specification in no way guarantees future production of the device in question.	Qualification
Product Specification	This document represents the anticipated production performance characteristics of the device.	Production

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